Passion For Making Scholarship Application Form

Fintech Industrial Abrasives is pleased to offer the annual Passion for Making Scholarship. We are looking to celebrate motivated and passionate students who make things. The recipient will be awarded a \$500 financial aid scholarship to go toward the expenses of his or her education. We are excited to provide this opportunity to students, and look forward to reviewing the application submissions!

TUDENT INFORMAT	TION:		
Name (Last, First, M	II):		
Are you a U.S. citize	n or otherwise authorized to	work in the United States?Ye	sNo
Name and city of sc	hool you attend or plan to att	tend:	
Present mailing add	ress (Street, Apt. # City, State	e, Zip code):	
Telephone #:			
E-Mail:			
ACADEMIC INFORM	IATION:		
Schools	Address	Degree / Major	Date of Graduation
L			
Highlight honors or	awards that you have receive	ed:	

Is there any other relevant information you want us to consider when reviewing your application?

ELIGIBILITY:

To be eligible for the scholarship, applicants must be full-time students, entering or attending a university, college, or trade school in the United States and must maintain a GPA of at least 3.0.

To apply, candidates must submit the following materials electronically before August 15th:

- This completed application form
- A certified copy of the student's current university or high-school transcript that confirms the student's full-time status and grade-point average of at least 3.0.
- Your passion for making submission. Submissions can be in the form of an essay, poem, video, animation, photo, graphic, or other multimedia item.

CERTIFICATION:

The undersigned scholarship applicant hereby grants permission to use his/her name and to quote his/her essay (in whole or in part) or use his/her Entry (in whole or in part) in all promotional and other activities relating to the scholarship, including, but not limited to, publication in written materials, and posting on websites and other social media.

Any taxes on scholarship are the sole responsibility of the contestant.

I hereby certify that the information I have provided on this Application Form and in any attached materials is true and complete. Applicant Signature:
Date: